

1-23-03



102352693

Attached original documents or copy thereof.

To the Honorable Commissioner of Patents

Name of conveying party(ies):
Kun-Long Lin Meng-Huang Chu

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)

Name: **Via Technologies, Inc.**

Internal Address:

Street Address: **8 Fl., No. 533, Jungjeng Road, Shindian City**

City: **Taipei** Country: **Taiwan, R.O.C.** Zip: **231**

Additional name(s) and address(es) attached? Yes No

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other _____

Execution Date: **May 10, 2002**

4. Application number(s) or patent number(s):

10349983

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: **Evan R. Witt, MADSON & METCALF**

Internal Address:

Street Address: **15 West South Temple, Suite 900**

City: **Salt Lake City** State: **Utah** ZIP: **84101**

6. Total number of applications and patents involved:

7. Total fee (37 CFR 3.41) \$ **40.00**

Enclosed

Authorized to be charged to deposit account (any deficiencies)

8. Deposit account number:

13-0763

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Evan R. Witt
Name of Person Signing

Signature

January 23, 2003
Date

Total number of pages including cover sheet, attachments, and document:

Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents and Trademarks, Box Assignments
Washington, D.C. 20231

10/349983
01/23/03

ASSIGNMENT OF APPLICATION

Whereas, I/we, the below named inventor(s), hereafter referred to as applicant(s), have invented certain new and useful improvements in PAD CIRCUIT AND METHOD FOR AUTOMATICALLY ADJUSTING GAIN FOR THE SAME

- for which an application for a United States patent was filed on _____, Application Number _____.
- for which an application for a United States patent was executed on May 10, 2002, and

Whereas, VIA TECHNOLOGIES, INC. of TAIWAN, R.O.C. herein referred to as "assignee" whose mailing address is 8Fl., No. 533, Jungjeng Rd., Shindian City, Taipei, Taiwan 231, R.O.C. is desirous of acquiring the entire right, title and interest in the same;

Now, therefore, for good and valuable consideration, the receipt of whereof is acknowledged, I/we, the applicant(s), by these presents do sell, assign and transfer unto said assignee the full and exclusive right to the said invention in the United States and the entire right, title and interest in and to any and all Patents which may be granted therefore in the United States, I/we hereby authorize and request the Commissioner of Patent and Trademarks to issue said United States patent to said assignee of the entire right, title, and interest in and to the same, for his sole use and benefit, and for the use and benefit of his legal representatives, to the full end of the term for which said Patent may be granted, as fully and entirely as the same would have been held by me had this assignment and sale not been made.

Executed this 10th day of May, 2002
at 8Fl., No. 533, Jungjeng Rd., Shindian City, Taipei, Taiwan 231, R.O.C.

Kun-Long Lin
Kun-Long Lin

Meng-Huang Chu
Meng-Huang Chu

Both at 8Fl., No. 533, Jungjeng Rd., Shindian City, Taipei, Taiwan 231, R.O.C.